

1. General Description

The EM74AHC2G04; EM74AHCT2G04 is a dual inverter. Inputs are overvoltage tolerant. This feature allows the use of these devices as translators in mixed voltage environments.

2. Features and Benefits

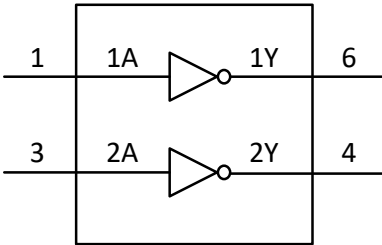
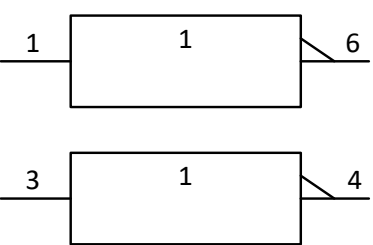
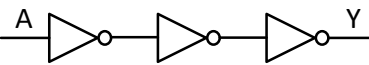
- Wide supply voltage range from 2.0 V to 5.5 V
- Overvoltage tolerant inputs to 5.5 V
- High noise immunity
- CMOS low power dissipation
- Latch-up performance exceeds 200 mA
- Symmetrical output impedance
- Balanced propagation delays
- Input levels:
 - For EM74AHC2G04: CMOS level
 - For EM74AHCT2G04: TTL level
- ESD protection:
 - HBM ANSI/ESDA/JEDEC JS-001 Class 3A exceeds 7000 V
 - CDM ANSI/ESDA/JEDEC JS-002 Class C3 exceeds 2000 V
- Multiple package options

3. Ordering Information

Table 1. Ordering information

Type number	Topside marking	Package		
		Name	Description	Quantity
EM74AHC2G04GV	AYYW	SOT23-6L	SOT23 package, 6 pins 2.92 mm × 1.6 mm; 1.25 mm (Max) height	3000
EM74AHCT2G04GV	CYYW			
EM74AHC2G04GW	AYYW	SOT363	SOT363 package, 6 pins 2.1 mm × 1.25 mm; 1.1 mm (Max) height	3000
EM74AHCT2G04GW	CYYW			
EM74AHC2G04DRL	AYYW	SOT563	SOT563 package, 6 pins 1.6 mm × 1.2 mm; 0.6 mm (Max) height	3000
EM74AHCT2G04DRL	CYYW			

4. Function Diagram

 Fig. 1. Logic symbol	 Fig. 2. IEC logic symbol	 Fig. 3. Logic diagram(one gate)
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5. Pinning Information

5.1. Pinning

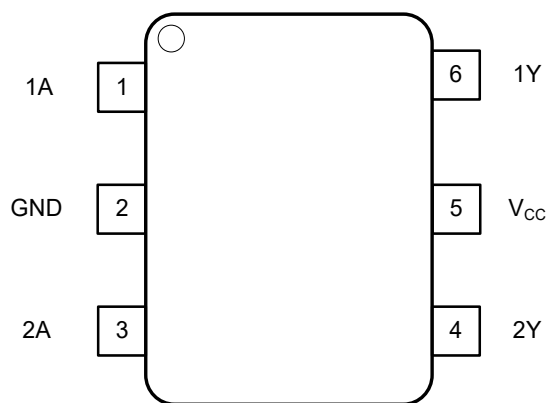


Fig. 4. Top view pin configuration SOT23-6, SOT363 and SOT563

5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1A	1	Data input
GND	2	Ground (0V)
2A	3	Data input
2Y	4	Data output
V _{cc}	5	Supply voltage
1Y	6	Data output

6. Functional Description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level.

Input	Output
nA	nY
L	H
H	L

7. Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Table 4. Absolute Maximum Ratings

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND.

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	7.0	V
I_{IK}	input clamping current	$V_I < -0.5\text{ V}$	-20		mA
V_I	input voltage		-0.5	7.0	V
I_{OK}	output clamping current	$V_O > V_{CC} + 0.5\text{ V}$ or $V_O < -0.5\text{ V}$ [1]		± 20	mA
I_O	output current	$-0.5\text{ V} < V_O < V_{CC} + 0.5\text{ V}$		± 25	mA
I_{CC}	supply current			75	mA
I_{GND}	ground current		-75		mA
P_{tot}	total power dissipation	$T_{amb} = -40\text{ °C to } +125\text{ °C}$		250	mW
T_{stg}	storage temperature		-65	150	°C

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

8. Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. EnergyMath does not recommend exceeding them or designing to Absolute Maximum Ratings.

Table 5. Recommended Operating Conditions

Symbol	Parameter	Conditions	EM74AHC2G04			EM74AHCT2G04			Unit
			Min	Typ	Max	Min	Typ	Max	
V_{CC}	supply voltage		2.0	5.0	5.5	4.5	5.0	5.5	V
V_I	input voltage		0		5.5	0		5.5	V
V_O	output voltage		0		V_{CC}	0		V_{CC}	V
T_{amb}	ambient temperature		-40		125	-40		125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$			100				ns/V
		$V_{CC} = 5.0\text{ V} \pm 0.5\text{ V}$			20			20	ns/V

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9.Static Characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
EM74AHC2G04								
V _{IH}	HIGH-level input voltage	V _{CC} = 2.0 V	1.5			1.5		V
		V _{CC} = 3.0 V	2.1			2.1		V
		V _{CC} = 5.5 V	3.85			3.85		V
V _{IL}	LOW-level input voltage	V _{CC} = 2.0 V			0.5		0.5	V
		V _{CC} = 3.0 V			0.9		0.9	V
		V _{CC} = 5.5 V			1.65		1.65	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL}						
		I _O = -50 μA; V _{CC} = 2.0 V	1.9			1.9		V
		I _O = -50 μA; V _{CC} = 3.0 V	2.9			2.9		V
		I _O = -50 μA; V _{CC} = 4.5 V	4.4			4.4		V
		I _O = -4.0 mA; V _{CC} = 3.0 V	2.48			2.40		V
		I _O = -8.0 mA; V _{CC} = 4.5 V	3.8			3.75		V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}						
		I _O = 50 μA; V _{CC} = 2.0 V		0	0.1		0.1	V
		I _O = 50 μA; V _{CC} = 3.0 V		0	0.1		0.1	V
		I _O = 50 μA; V _{CC} = 4.5 V		0	0.1		0.1	V
		I _O = 4.0 mA; V _{CC} = 3.0 V		0.05	0.44		0.55	V
		I _O = 8.0 mA; V _{CC} = 4.5 V		0.07	0.44		0.55	V
I _I	input leakage current	V _I = 5.5 V or GND ; V _{CC} = 0 V to 5.5 V		±0.01	±1		±2	μA
I _{CC}	supply current	V _I = V _{CC} or GND ; I _O = 0A ; V _{CC} = 5.5V		0.01	10		40	μA
C _I	input capacitance			3.5				pF

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Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
EM74AHCT2G04								
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0			2.0		V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V			0.8		0.8	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL}						
		I _O = -50 μA; V _{CC} = 4.5 V	4.4	4.5		4.4		V
		I _O = -8.0 mA; V _{CC} = 4.5 V	3.8	4.39		3.7		V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}						
		I _O = 50 μA; V _{CC} = 4.5 V		0	0.1		0.1	V
		I _O = 8.0 mA; V _{CC} = 4.5 V		0.07	0.44		0.55	V
I _I	input leakage current	V _I = 5.5 V or GND ; V _{CC} = 0 V to 5.5 V		±0.01	±1		±2	μA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V		0.01	10		40	μA
ΔI _{CC}	additional supply current	per input pin; V _I = 3.4 V; other inputs at V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V		0.23	1.35		1.35	mA
C _I	input capacitance			3.5				pF

[1] All typical values are measured at $T_{amb} = 25^\circ\text{C}$.

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10. Dynamic Characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 6.

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
EM74AHC2G04								
t _{pd}	propagation delay	A to Y; see Fig. 5 [2]						
		V _{CC} = 3.0 V to 3.6 V, C _L =15 pF	1	4.3	9.5	1	10	ns
		V _{CC} = 4.5 V to 5.5 V, C _L =15 pF	1	3.1	6.5	1	7	ns
C _{PD}	power dissipation capacitance	C _L = 15 pF; f = 1 MHz; V _I = GND to V _{CC} [3]		20				pF
EM74AHCT2G04								
t _{pd}	propagation delay	A to Y; see Fig. 5 [2]						
		V _{CC} = 4.5 V to 5.5 V, C _L =15 pF	1	4.3	8	1	8.5	ns
C _{PD}	power dissipation capacitance	C _L = 15 pF; f = 1 MHz; V _I = GND to V _{CC} [3]		21				pF

[1] Typical values are measured at $T_{amb} = 25 \text{ °C}$ and $V_{CC} = 3.3 \text{ V}$ and 5.0 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz;

f_o = output frequency in MHz;

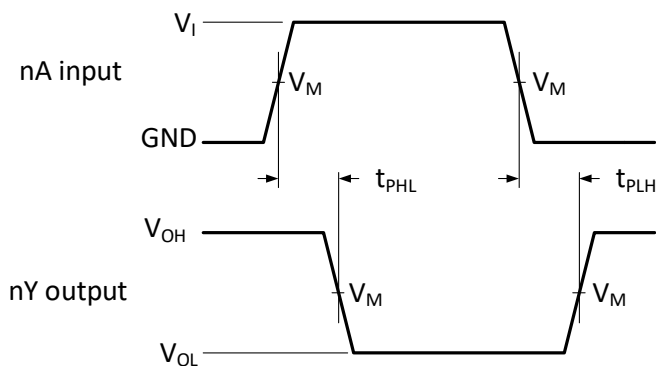
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

10.1. Waveforms and test circuit



Measurement points are given in Table 8.

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

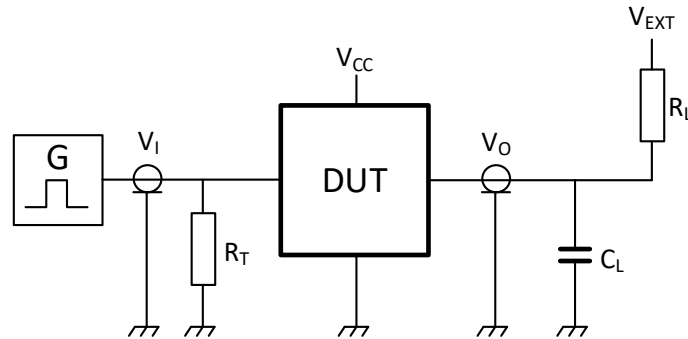
Fig. 5. Input nA to output nY propagation delays

Table 8. Measurement points

Type	Input	Input	Output
	V_I	V_M	V_M
EM74AHC2G04	GND to V_{CC}	$0.5V_{CC}$	$0.5V_{CC}$
EM74AHCT2G04	GND to 3.0 V	1.5V	$0.5V_{CC}$

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Test data is given in Table 9.

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator.

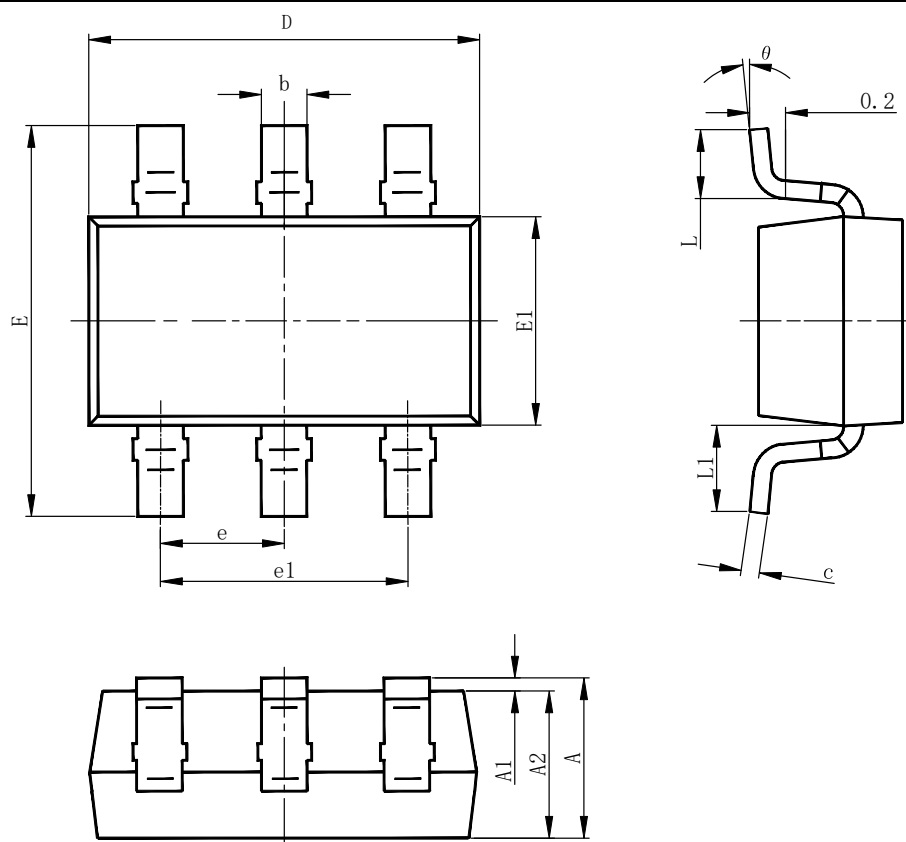
V_{EXT} = External voltage for measuring switching times.

Fig. 6. Test circuit for measuring switching times

Table 9. Test data

Input	Load		V_{EXT}
$t_r = t_f$	C_L	R_L	t_{PLH}, t_{PHL}
$\leq 2 \text{ ns}$	15 pF	500 Ω	open

11. Package Outline

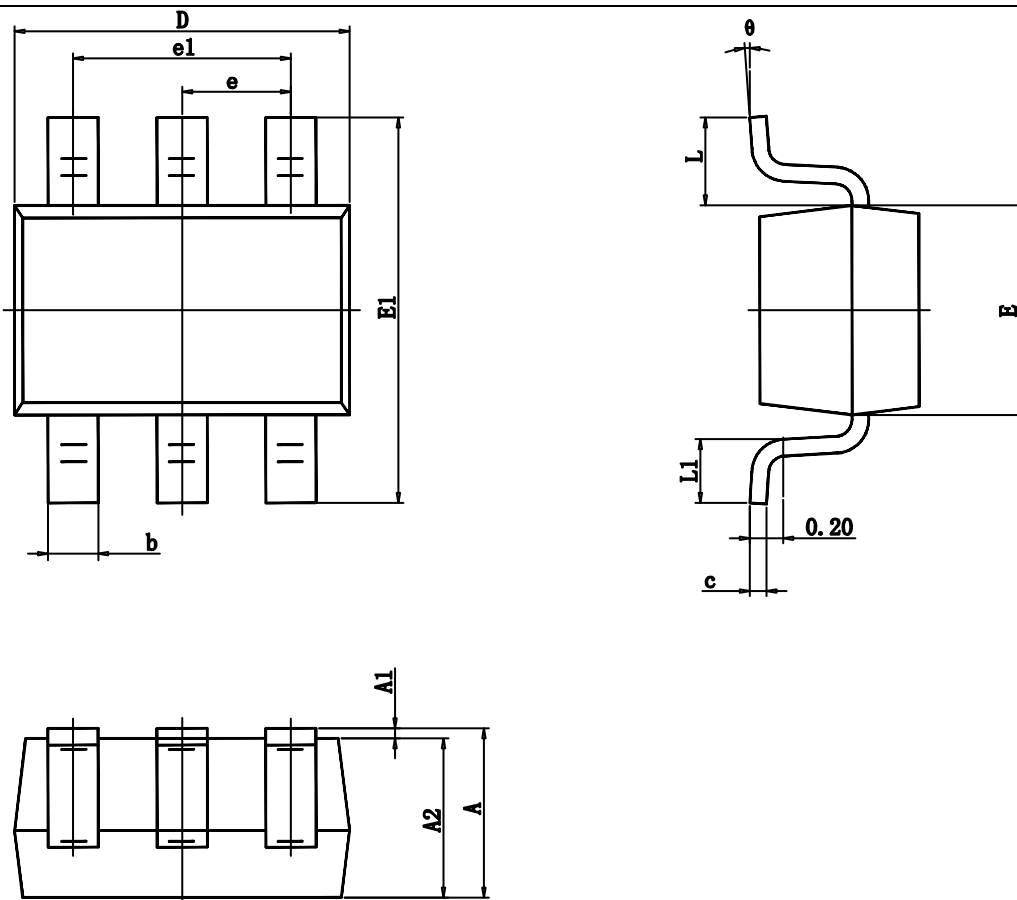
SOT23-6L


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E1	1.500	1.700	0.059	0.067
E	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
L1	0.600REF.		0.024REF.	
θ	0°	8°	0°	8°

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SOT363

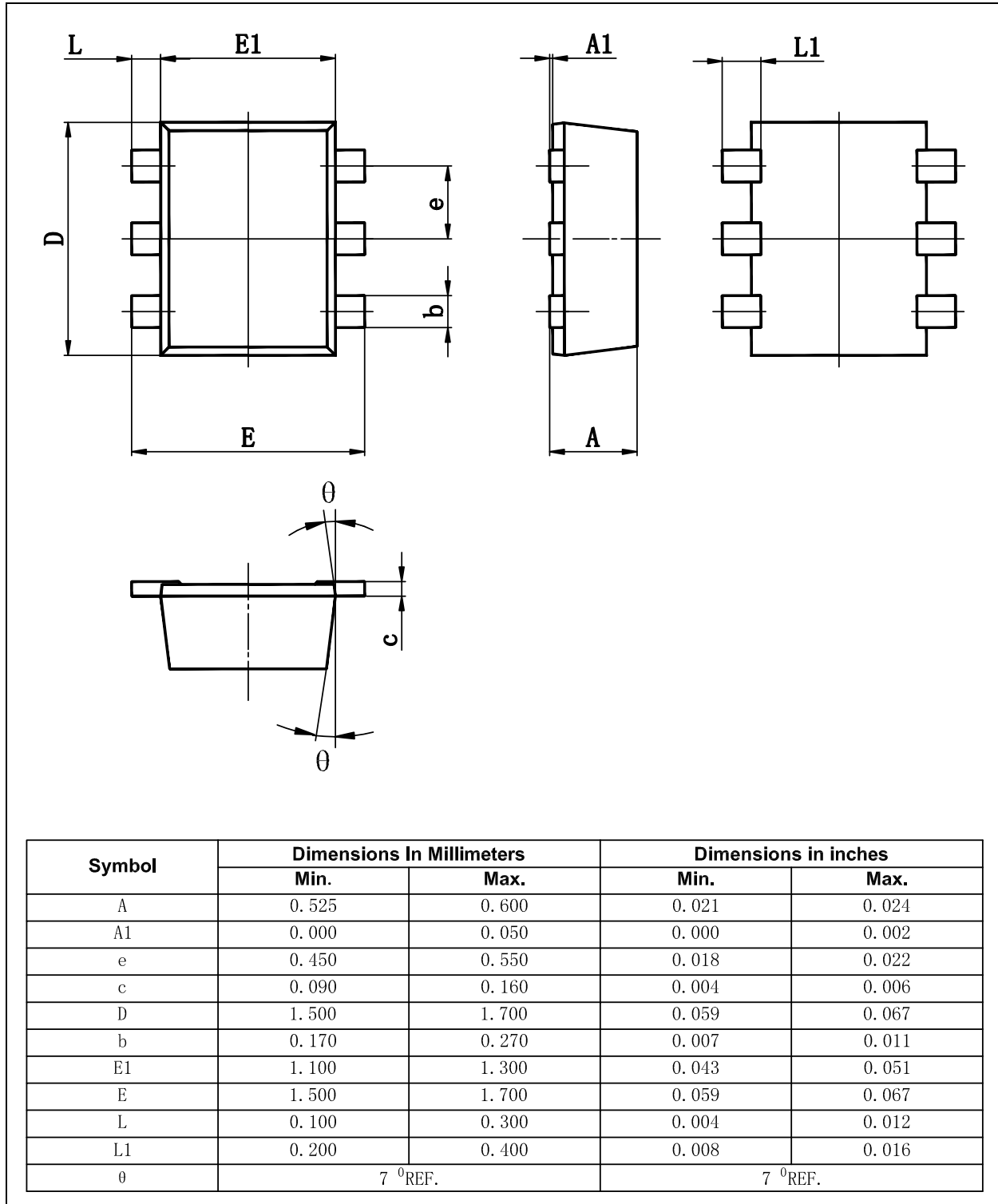


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.110	0.175	0.004	0.007
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP.		0.026 TYP.	
e1	1.200	1.400	0.047	0.055
L	0.525 REF.		0.021 REF.	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

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SOT563



12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
CDM	Charged Device Model
TTL	Transistor-Transistor Logic

13. Revision History

Table 11. Revision history

Document ID	Release Date	Data sheet status	Change notice	Supersedes
EM74AHC_AHCT2G04 Rev. 1.1	Sept 14, 2024	Product datasheet		EM74AHC_AHCT2G04 Rev. 1.0
Modifications:	- Table 6: C_I updated. - Table 7: C_{PD} updated			
EM74AHC_AHCT2G04 Rev. 1.0	Apr 24, 2024	Product datasheet		